



PCB LAYOUT

- SPECIFI NS
- 1、Curr ating: 1A AC, DC
 - 2、Voltage Rating: 125V AC, DC
 - 3、Temperatuer Range: $-25^{\circ}\text{C} \sim +85^{\circ}\text{C}$
 - 4、Contact Resistance: $20\text{m}\Omega$ Max
 - 5、Insulation Resistance: $100\text{M}\Omega$ Min
 - 6、Withstanding Voltang: 500V AC/minute
 - 7、Material: Wafer LCP ,UL94V-0
PIN Brass Tin-plated

PIN	尺寸(mm)	
	A	B
02	1.25	4.25
03	2.50	5.50
04	3.75	6.75
05	5.00	8.00
06	6.25	9.25
07	7.50	10.50
08	8.75	11.75
09	10.00	13.00
10	11.25	14.25
11	12.50	15.50
12	13.75	16.75
20	23.75	26.75

凱帛企業有限公司 KABO ENTERPRISE CO.,LTD.		
Name Pitch:1.25mm Wafer DIP V/T TYPE		
Drawing No WF-1.25-2018-xx01N		
DR	-	APPD
General Tolerances : X.XX± X.X±	Unit : mm	Scale : ROM